



SPECIFICATION

(Reference sheet)

· Supplier : Samsung electro-mechanics · Samsung P/N : CL31A106KBHNNNE

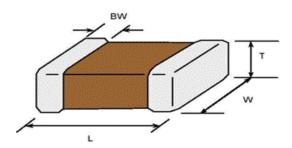
Product : Multi-layer Ceramic Capacitor Description : CAP, 10uF, 50V, ±10%, X5R, 1206

A. Samsung Part Number

<u>CL</u> <u>31</u> <u>A</u> <u>106</u> <u>K</u> <u>B</u> <u>H</u> <u>N</u> <u>N</u> <u>N</u> <u>E</u> 1 2 3 4 5 6 7 8 9 10 11

1	Series	Samsung Multi-layer Ceramic Capacitor					
2	Size	1206 (inch code)	L: $3.20 \pm 0.20 \text{ mm}$		W:	$1.60 \pm 0.20 \text{ mm}$	
3	Dielectric	X5R	8	Inner electrode		Ni	
4	Capacitance	10 uF		Termination		Cu	
(5)	Capacitance	±10 %		Plating		Sn 100% (Pb Free)	
	tolerance		9	Product		Normal	
6	Rated Voltage	50 V	10	Special		Reserved for future use	
7	Thickness	$1.60 \pm 0.20 \text{ mm}$	11	Packaging		Embossed Type, 7" reel	

B. Structure & Dimension



Samsung P/N	Dimension(mm)					
Samsung F/N	L	W	Т	BW		
CL31A106KBHNNNE	3.20 ± 0.20	1.60 ± 0.20	1.60 ± 0.20	0.50 ± 0.30		

C. Samsung Reliablility Test and Judgement Condition

	Judgement	Test condition			
Capacitance	Within specified tolerance	1kHz ±10% / 1.0±0.2Vrms			
Tan δ (DF)	0.1 max.	*A capacitor prior to measuring the capacitance is heat treated at 150°C+0/-10°C for 1 hour and maintained in ambient air for 24±2 hours.			
Insulation	10,000Mohm or 500Mohm×μF	Rated Voltage 60~120 sec.			
Resistance	Whichever is smaller				
Appearance No abnormal exterior appearance		Microscope (×10)			
Withstanding	No dielectric breakdown or	250% of the rated voltage			
Voltage	mechanical breakdown				
Temperature	X5R				
Characteristics	(From-55 ℃ to 85 ℃, Capacitance change should be within ±15%)				
Adhesive Strength	No peeling shall be occur on the	500g·f, for 10±1 sec.			
of Termination	terminal electrode				
Bending Strength	Capacitance change : within ±12.5%	Bending to the limit (1mm)			
		with 1.0mm/sec.			
Solderability	More than 75% of terminal surface	SnAg3.0Cu0.5 solder			
	is to be soldered newly	245±5°C, 3±0.3sec.			
		(preheating : 80~120°C for 10~30sec.)			
Resistance to	Capacitance change : within ±7.5%	Solder pot : 270±5℃, 10±1sec.			
	Tan δ, IR : initial spec.				
Vibration Test	Capacitance change : within \pm 5% Tan δ , IR : initial spec.	Amplitude: 1.5mm From 10Hz to 55Hz (return: 1min.) 2hours × 3 direction (x, y, z)			
Moisture	Capacitance change: within ±12.5%	With rated voltage			
Resistance	Tan δ : 0.125 max	40±2°C, 90~95%RH, 500+12/-0hrs			
	IR: 500Mohm or 12.5Mohm × µF Whichever is smaller				
High Temperature	Capacitance change : within ±12.5%	With 150% of the rated voltage			
Resistance	Tan δ : 0.125 max	Max. operating temperature			
	IR : 1,000Mohm or 25Mohm × Whichever is smaller	1,000+48/-0hrs			
Temperature	Capacitance change: within ±7.5%	1 cycle condition			
Cycling	Tan δ, IR : initial spec.	Min. operating temperature → 25°C			
		→ Max. operating temperature → 25°C			
		5 cycle test			

D. Recommended Soldering method:

Reflow (Reflow Peak Temperature : 260±5°C, 30sec.)



Product specifications included in the specifications are effective as of March 1, 2013.

Please be advised that they are standard product specifications for reference only.

We may change, modify or discontinue the product specifications without notice at any time.

So, you need to approve the product specifications before placing an order.

Should you have any question regarding the product specifications,

please contact our sales personnel or application engineers.

- Disclaimer & Limitation of Use and Application -

The products listed in this Specification sheet are **NOT** designed and manufactured for any use and applications set forth below.

Please note that any misuse of the products deviating from products specifications or information provided in this Spec sheet may cause serious property damages or personal injury.

We will **NOT** be liable for any damages resulting from any misuse of the products, specifically including using the products for high reliability applications as listed below.

If you have any questions regarding this 'Limitation of Use and Application', you should first contact our sales personnel or application engineers.

- ① Aerospace/Aviation equipment
- ② Automotive or Transportation equipment (vehicles, trains, ships, etc)
- 3 Medical equipment
- Military equipment
- 5 Disaster prevention/crime prevention equipment
- Any other applications with the same as or similar complexity or reliability to the applications set forth above.